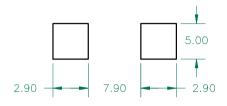
## MGV12032R2M-10

## PHYSICAL DIMENSIONS:

A 13.50 ± 0.50 B 12.60 ± 0.30 C 3.50 ± 0.30 D 3.60 ± 0.50 E 2.30 ± 0.50

## LAND PATTERNS FOR REFLOW SOLDERING

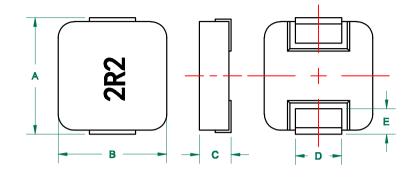




## ELECTRICAL SPECIFICATION @ 25°C

	Min	Nom	Max
INDUCTANCE (uH) L @ 100 KHz/0.25V ± 20%	1.76	2.20	2.64
DCR <b>(Ω)</b>			0.008

Saturation Current <sup>3</sup> Isat (A)	29.00
Temperature Rise Current Irms ⁴(A)	16.00









NOTES: UNLESS OTHERWISE SPECIFIED

- 1.COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2.OPERATION TEMPERATURE RANGE:
  - -40°C~+125°C (INCLUDING SELF-HEATING).
- 3.SATURATION CURRENT Isat IS DEFINED AS MAXIMUM AMOUNT OF CURRENT BY WHICH INDUCTANCE WILL DROP BY TYPICAL VALUE OF 25% OF INITIAL INDUCTANCE (Ta=25±5°C).
- 4.TEMPERATURE RISE CURRENT (Irms): DC CURRENT THAT CAUSES THE TEMPERATURE RISE (  $\Delta T \leq 40^{\circ}$ C) FROM 25°C AMBIENT.

Į		DIMENSIONS ARE IN mm.		This print is the property of Laird						
ŀ					subject to return upon request ar with the understanding that no	nd	Laird			
ļ					written consent of Laird Tech. All					
ŀ					rights to design or invention are reserved.					
ŀ					PROJECT/PART NUMBER:	REV	PART TY	PE:	DRAWN BY:	
Į					MGV12032R2M-10	В		WER CTOR	QIU	
	В	ADD CURVE	05/14/13	QU	DATE: 05/14/13	ALE: N	ITS	SHEET:		
Ī	Α	ORIGINAL DRAFT	01/30/12	QIU		OL #	113			
	REV	DESCRIPTION	DATE	INT	MGV12032R2M-10-B	~~ ,	-	1	of 1	